

APPLICATION NOTE

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(Taking charge of Silicon RF by
MIYOSHI Electronics)

SUBJECT: Electro Static Sensitivity for RA30H4552M1 and RA30H4047M1

GENERAL:

RA30H4552M1 and RA30H4047M1 use MOS FET device.

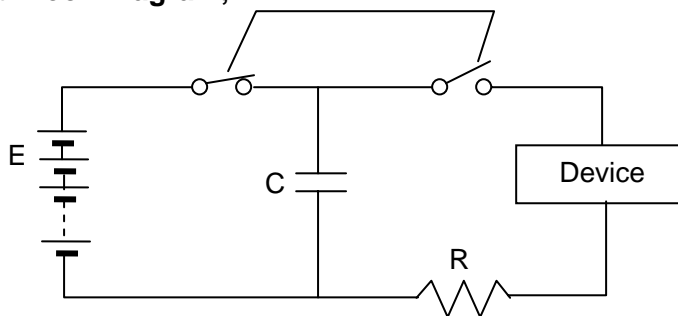
MOS FET devices have lower surge endurance compared with silicon bipolar devices.

And there is a possibility of burn-out when static electricity or surge is added to devices.

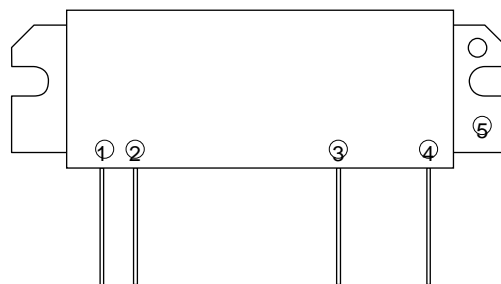
This application note shows the test results of the electro static discharge level for RA30H4552M1 and RA30H4047M1.

1. ELECTRO STATIC DISCHARGE TEST RESULTS:

-1. Test Block Diagram;

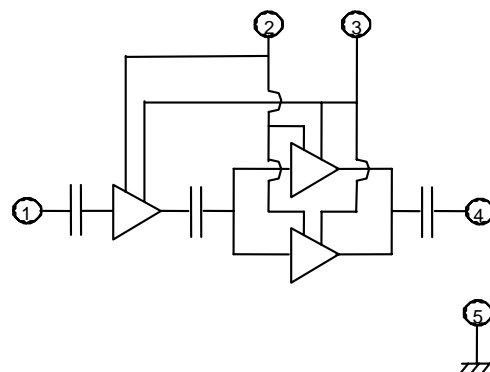


-2. Pinning;



- 1 RF Input (P_{in})
- 2 Gate Voltage (V_{GG})
- 3 Drain Voltage (V_{DD})
- 4 RF Output (P_{out})
- 5 RF Ground (Flange)

(Block Diagram)



-3. Human Model Test Results;

[Type number: RA30H4047M1 (Po>30W @400-470MHz, Vdd=12.5V)]

Test Conditions are;

C=100pF, R=1.5KΩ, 3 times discharge for one Voltage,

E=100V step increasing (Max. 6000V)

| Terminal | Polarity | Sample NO. | Destroyed Voltage(V) | Polarity | Sample NO. | Destroyed Voltage(V) |
|----------------|----------|------------|----------------------|----------|------------|----------------------|
| Pin to Flange | + | 1 | 1400 | - | 1 | -2700 |
| | | 2 | 1400 | | 2 | -2600 |
| Vgg to Flange | + | 1 | 2600 | - | 1 | Over -6000 |
| | | 2 | 2600 | | 2 | Over -6000 |
| Vdd to Flange | + | 1 | Over 6000 | - | 1 | Over -6000 |
| | | 2 | Over 6000 | | 2 | Over -6000 |
| Pout to Flange | + | 1 | Over 6000 | - | 1 | Over -6000 |
| | | 2 | Over 6000 | | 2 | Over -6000 |

NOTE: Test of RA30H4552M1 that is derivative from RA30H4047M1 is omitted for the same type under this test.